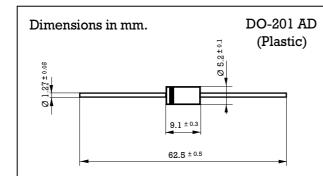


3 Amp. Glass Passivated Avalanche Ultrafast Recovery Rectifier



Voltage Current 200 V 3 A at 55 °C

Mounting instructions

- 1. Min. distance from body to soldering point, 4 mm.
- 2. Max. solder temperature, 350 °C.
- 3. Max. soldering time, 3.5 sec.
- 4. Do not bend lead at a point closer than 3 mm. to the body.

• Glass Passivated Junction

- High current capability
- The plastic material carries U/L recognition 94 V-0
- Terminals: Axial Leads
- Polarity: Color band denotes cathode

Maximum Ratings, according to IEC publication No. 134

		EGP30DT
V _{RRM}	Peak Recurrent reverse voltage	200 V
V _{RMS}	Maximum RMS voltage	140 V
V _{DC}	Maximum DC blocking voltage	200 V
$I_{F(AV)}$	Forward current at Tamb = 55 °C	3 A
I_{FRM}	Recurrent peak forward current	30 A
I_{FSM}	8.3 ms. peak forward surge current (Jedec Method)	125 A
t _{rr}	Max. reverse recovery time from $I_F = 0.5 \text{ A}$; $I_R = 1 \text{ A}$; $I_{RR} = 0.25 \text{ A}$	35 ns
C_{j}	Typical Junction Capacitance at 1 MHz and reverse voltaje of $4V_{\tiny DC}$	100 pF
T_{j}	Operating temperature range	− 65 to + 150 °C
$T_{ m stg}$	Storage temperature range	− 65 to + 150 °C
$E_{ ext{RSM}}$	Maximum non repetitive peak reverse avalanche energy. $I_R = 1.0 \text{ A} \; ; \; T_J = 25 ^{\circ}\text{C}$	20 mJ

Electrical Characteristics at Tamb = 25 °C

$V_{\rm F}$	Max. forward voltage drop at $I_F = 3 \text{ A}$	0.9 V
I_R	Max. reverse current at V_{RRM} at 25 °C at 150 °C	5 μ A 50 μ A
R_{thj}	Max. thermal resistance (l = 10 mm.)	30 °C/W



Rating And Characteristic Curves

